SCAS416L - MARCH 1994 - REVISED FEBRUARY 2004

DGG OR DL PACKAGE

Member of	the	Texas	Instruments
Widebus™	Fan	nily	

- Max t_{pd} of 5.8 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17

description/ordering information

This 16-bit (dual-octal) noninverting bus transceiver contains two separate supply rails. B port has V_{CCB} , which is set to operate at 3.3 V and 5 V. A port has V_{CCA} , which is set to operate at 2.5 V and 3.3 V. This allows for translation from a 2.5-V to a 3.3-V environment, and vice versa, or from a 3.3-V to a 5-V environment, and vice versa.

The SN74ALVC164245 is designed for asynchronous communication between data buses.

To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

(TOP VIEW)								
1DIR [1B1 [1B2 [GND [1B3 [1B4 [(3.3 V, 5 V) V _{CCB} [1B5 [1B6 [GND [1B7 [1 2 3 4 5 6 7 8 9 10 11 12 13 14 15	48] 10E 47] 1A1 46] 1A2 45] GND 44] 1A3 43] 1A4 42] V _{CCA} (2.5 V, 3.3 V) 41] 1A5 40] 1A6 39] GND 38] 1A7 37] 1A8 36] 2A1 35] 2A2 34] GND						
2B2 [GND [2B3 [2B4 [(3.3 V, 5 V) V _{CCB} [2B5 [2B6 [GND [14 15 16 17 18 19 20 21 22 23	35 2A2						

ORDERING INFORMATION

TA	PACKAGE [†]		PACKAGE [†] ORDERABLE PART NUMBER	
	CCOD DI	Tube of 25	SN74ALVC164245DL	ALV/0404045
	SSOP – DL	Reel of 1000	SN74ALVC164245DLR	ALVC164245
4000 1- 0500		Reel of 2000	SN74ALVC164245DGGR	411/0404045
-40°C to 85°C	TSSOP - DGG	Reel of 250	SN74ALVC164245DGGT	ALVC164245
	VFBGA – GQL	B 1 (4000	SN74ALVC164245KR	V0.40.45
	VFBGA – ZQL (Pb-free)	Reel of 1000	74ALVC164245ZQLR	VC4245

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each 8-bit section)

INP	UTS	
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation



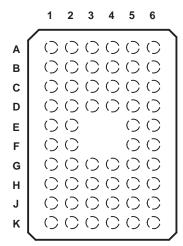
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GQL OR ZQL PACKAGE (TOP VIEW)

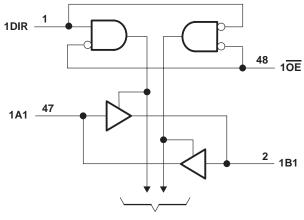


terminal assignments

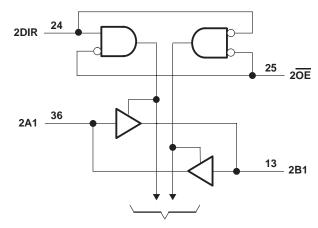
	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 OE
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	VCCB	VCCA	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
Ε	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	VCCB	VCCA	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2 <mark>OE</mark>

NC - No internal connection

logic diagram (positive logic)







To Seven Other Channels

Pin numbers shown are for the DGG and DL packages.

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absolute maximum ratings over operating free-air temperature range for V_{CCB} at 5 V and V_{CCA} at 3.3 V (unless otherwise noted)[†]

Supply voltage range: V _{CCA}	0.5 V to 4.6 V
V _{CCB}	0.5 V to 6 V
Input voltage range, V _I : Except I/O ports (see Note 1)	0.5 V to 6 V
I/O port A (see Note 2)	0.5 V to V _{CCA} + 0.5 V
I/O port B (see Note 1)	0.5 V to V _{CCB} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, IO	±50 mA
Continuous current through each V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DGG pack	age 70°C/W
DL packag	je 63°C/W
GQL/ZQL	package 42°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. This value is limited to 6 V maximum.
 - 2. This value is limited to 4.6 V maximum.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions for V_{CCB} at 3.3 V and 5 V (see Note 4)

			MIN	MAX	UNIT
VCCB	Supply voltage		3	5.5	V
VIH	High-level input voltage		2		V
.,	Lauriania iaminti valtama	V _{CCB} = 3 V to 3.6 V		0.7	V
V _{IL}	Low-level input voltage	V _{CCB} = 4.5 V to 5.5 V		8.0	V
VIA	Input voltage		0	VCCB	V
VOB	Output voltage		0	VCCB	V
ІОН	High-level output current			-24	mA
lOL	Low-level output current			24	mA
Δt/Δν	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temper	ature	-40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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recommended operating conditions for V_{CCA} at 2.5 V and 3.3 V (see Note 4)

			MIN	MAX	UNIT	
VCCA	Supply voltage		2.3	3.6	V	
V	VCCA	= 2.3 V to 2.7 V	1.7		.,	
VIH	High-level input voltage VCCA	= 3 V to 3.6 V	2		V	
V _{IL}	VCCA	= 2.3 V to 2.7 V		0.7	.,	
	Low-level input voltage VCCA	= 3 V to 3.6 V		8.0	V	
V _{IB}	Input voltage				V	
VOA	Output voltage		0	VCCA	V	
	VCCA	= 2.3 V		-18	A	
ЮН	High-level output current	= 3 V		-24	mA	
	VCCA	= 2.3 V		18	4	
lOL	Low-level output current VCCA	= 3 V		24	mA	
Δt/Δν	Input transition rise or fall rate			10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.7 V to 3.6 V and V_{CCB} = 4.5 V to 5.5 V (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	VCCA	VCCB	MIN	TYP† I	VIAX	UNIT	
		I _{OH} = -100 μA	2.7 V to 3.6 V		V _{CC} -0.2	!			
\	2.1- A)	10.00	2.7 V		2.2			.,	
V _{OH} (E	3 to A)	I _{OH} = -12 mA	3 V		2.4			V	
		I _{OH} = -24 mA	3 V		2				
				4.5 V	4.3				
		I _{OH} = -100 μA		5.5 V	5.3			.,	
VOH (A	A to B)			4.5 V	3.7			V	
		I _{OH} = -24 mA		5.5 V	4.7				
		I _{OL} = 100 μA	2.7 V to 3.6 V				0.2		
VOL (E	3 to A)	I _{OL} = 12 mA	2.7 V				0.4	V	
		I _{OL} = 24 mA	3 V				0.55		
		I _{OL} = 100 μA		4.5 V to 5.5 V			0.2		
VOL (A	A to B)	I _{OL} = 24 mA		4.5 V to 5.5 V			0.55	V	
II	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	3.6 V	5.5 V			±5	μΑ	
loz‡	A or B ports	VO = VCCA/VCCB or GND	3.6 V	5.5 V			±10	μΑ	
ICC	•	V _I = V _{CCA} /V _{CCB} or GND, I _O = 0	5.5 V	5.5 V			40	μΑ	
ΔlCC§		One input at V _{CCA} /V _{CCB} – 0.6 V, Other inputs at V _{CCA} /V _{CCB} or GND	3 V to 3.6 V	4.5 V to 5.5 V			750	μΑ	
Ci	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	3.3 V	5 V		6.5		pF	
C _{io}	A or B ports	V _O = V _{CCA} /V _{CCB} or GND	3.3 V	3.3 V		8.5		pF	

[†] Typical values are measured at $V_{CCA} = 3.3 \text{ V}$ and $V_{CCB} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[‡] For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated VCC.

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electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.3 V to 2.7 V and V_{CCB} = 3 V to 3.6 V (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	V _{CCA}	V _{CCB}	MIN	MAX	UNIT	
V _{OH} (B to A)		I _{OH} = -100 μA	2.3 V to 2.7 V	3 V to 3.6 V	V _{CCA} -0.2			
		I _{OH} = -8 mA	2.3 V	3 V to 3.6 V	1.7		V	
		I _{OH} = -12 mA	2.7 V	3 V to 3.6 V	1.8			
\//A	4- D)	I _{OH} = -100 μA	2.3 V to 2.7 V	3 V to 3.6 V	V _{CCB} -0.2		V	
V _{OH} (A to B)		I _{OH} = -18 mA	2.3 V to 2.7 V	3 V	2.2		V	
V (D	1- 4)	I _{OL} = 100 μA	2.3 V to 2.7 V	3 V to 3.6 V		0.2		
V _{OL} (B	to A)	I _{OL} = 12 mA	2.3 V	3 V to 3.6 V		0.6	V	
., ,,	(- D)	I _{OL} = 100 μA	2.3 V to 2.7 V	3 V to 3.6 V		0.2	.,	
V _{OL} (A	to B)	I _{OL} = 18 mA	2.3 V	3 V		0.55	V	
l _l	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V		±5	μΑ	
l _{OZ} †	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V		±10	μΑ	
Icc		$V_I = V_{CCA}/V_{CCB}$ or GND, $I_O = 0$	2.3 V to 2.7 V	3 V to 3.6 V		20	μΑ	
Δl _{CC} ‡		One input at V _{CCA} /V _{CCB} – 0.6 V, Other inputs at V _{CCA} /V _{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V		750	μΑ	

[†] For I/O ports, the parameter IOZ includes the input leakage current.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1-4)

			V _{CCB} = 3.3 V ± 0.3 V	V _{CCB} = 5	5 V ± 0.5 \		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCA} = 2.5 V ± 0.2 V	V _{CCA} = 2.7 V	V _{CCA} = 3.3 V ± 0.3 V		UNIT
			MIN MAX	MIN MAX	MIN	MAX	
4 .	Α	В	7.6	5.9	1	5.8	20
^t pd	В	А	7.6	6.7	1.2	5.8	ns
t _{en}	ŌĒ	В	11.5	9.3	1	8.9	ns
^t dis	ŌĒ	В	10.5	9.2	2.1	9.5	ns
t _{en}	ŌĒ	Α	12.3	10.2	2	9.1	ns
^t dis	ŌĒ	А	9.3	9	2.9	8.6	ns

operating characteristics, T_A = 25°C

				V _{CCB} = 3.3 V	V _{CCB} = 5 V	
	PARAMETER	TEST CONDITIONS	V _{CCA} = 2.5 V	V _{CCA} = 3.3 V	UNIT	
				TYP	TYP	
	Power dissipation capacitance	Outputs enabled (B)	C _I = 50 pF, f = 10 MHz	55	56	
		Outputs disabled (B)	C[= 50 pr, 1 = 10 MHZ	27	6	~F
C _{pd}		Outputs enabled (A)	C 50 pE	118	56	pF
		Outputs disabled (A)	$C_L = 50 \text{ pF}, f = 10 \text{ MHz}$	58	6	



[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated V_{CC}.

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power-up considerations[†]

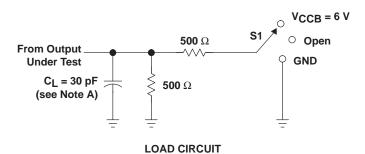
TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up the control side of the device (V_{CCA} for all four of these devices).
- 3. Tie $\overline{\text{OE}}$ to V_{CCA} with a pullup resistor so that it ramps with V_{CCA} .
- 4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA}. Otherwise, keep DIR low.

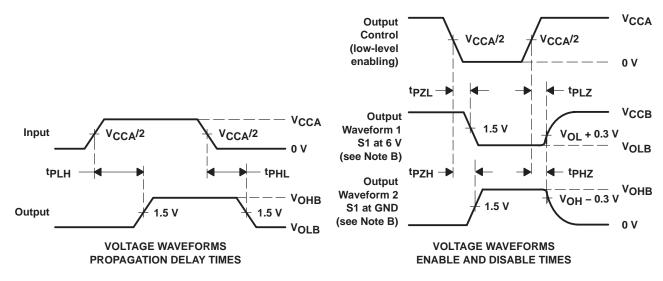
† Refer to the TI application report, Texas Instruments Voltage-Level-Translation Devices, literature number SCEA021.



PARAMETER MEASUREMENT INFORMATION V_{CCA} = 2.5 V \pm 0.2 V TO V_{CCB} = 3.3 V \pm 0.3 V



TEST	S1
t _{pd}	Open
tPLZ/tPZL	V _{CCB} = 6 V
tPHZ/tPZH	GND



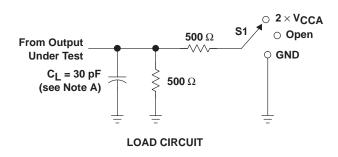
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z $_{O}$ = 50 Ω , $t_{f}\leq$ 2 ns. $t_{f}\leq$ 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

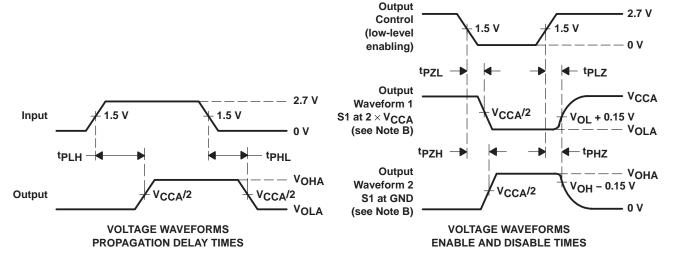
Figure 1. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION V_{CCB} = 3.3 V \pm 0.3 V TO V_{CCA} = 2.5 V \pm 0.2 V



TEST	S 1
tpd	Open
tpLZ/tpZL	2×V _{CCA}
tpHZ/tpZH	GND

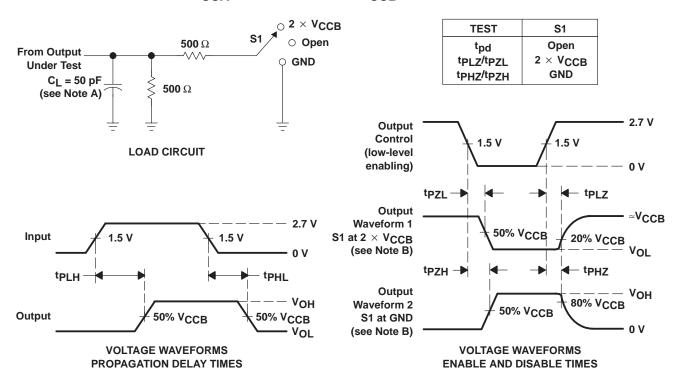


- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq$ 2 ns. $t_f \leq$ 2 ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tplH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ TO $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$



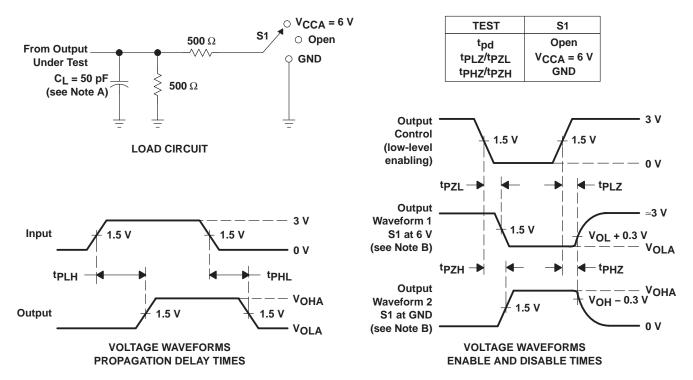
NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \, \Omega$, $t_f \leq 2.5 \, \text{ns}$, $t_f \leq 2.5 \, \text{ns}$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION V_{CCB} = 5 V \pm 0.5 V TO V_{CCA} = 2.7 V AND 3.3 V \pm 0.3 V



NOTES: A. C_I includes probe and jig capacitance.

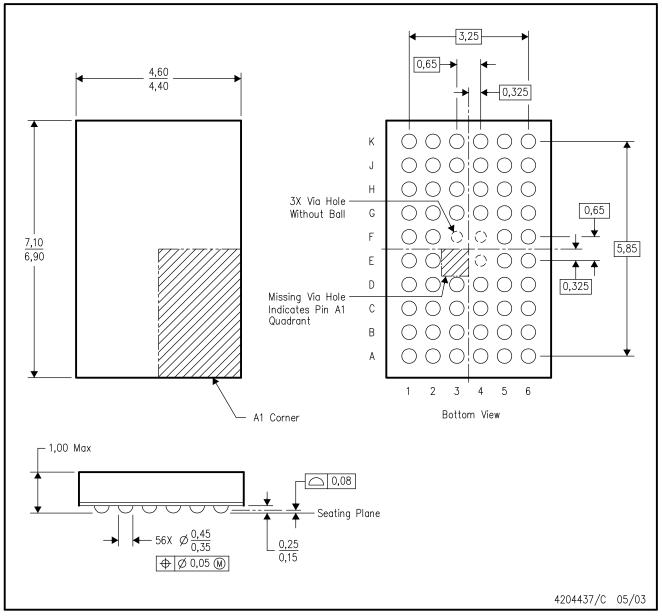
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzl and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 4. Load Circuit and Voltage Waveforms



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

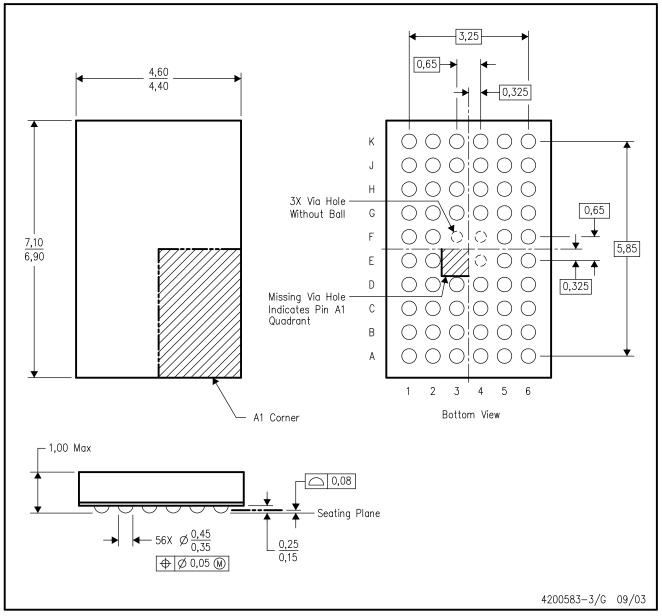
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is lead—free. Refer to the 56 GQL package (drawing 4200583) for tin—lead (SnPb).

MicroStar Junior is a trademark of Texas Instruments.



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

MicroStar Junior is a trademark of Texas Instruments.



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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